TPS54362EVM

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1 Introduction

The Texas Instruments TPS54362EVM evaluation module (EVM) helps designers evaluate the operation and performance of the TPS54362 Switch Mode Power Supply – Buck Regulator. The device offers configurability and can be setup to switch from 200KHz up to 2.2MHz.

The EVM contains one DC / DC converter (see Table 1).

Table 1. Device and Package Configurations

Converter	IC	Package
U1	TPS54362QPWPQ1	PWP-20

2 Setup

This section describes the jumpers and connectors on the EVM as well and how to properly connect, set up and use the TPS54362EVM.

2.1 Input/Output Connector Description

J1 – Input is the power input terminal for the converter. The terminal block provides a power (Vbat) and ground (GND) connection to allow the user to attach the EVM to a cable harness.

J2 – Output is the regulated output voltage for the converter. The terminal block provides a power (Vout) and ground (GND) connection to allow the user to attach the EVM to a cable harness.

J3 – Sync is the input terminal for an optional external input clock to the converter. The external clock can be used to synchronize the switching frequency for multiple devices. The external clock frequency must meet the Fsw<Fext<2×Fsw guideline, if used.

JP1 – LPM is the jumper used to enable Low Power Mode. The jumper allows LPM to be enabled or disabled. The “disabled with protection diode” selection should be used if the output voltage is programmed for voltages greater than 5 V. The external zener will prevent over voltage damage to the LPM input.

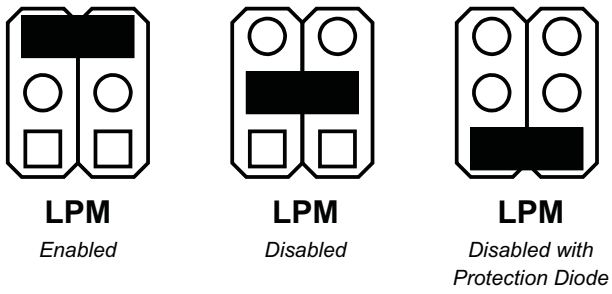


Figure 1. LPM Jumper Settings

JP2 – Enable is the jumper used to enable the converter. The converter will be enabled when the Enable is high and disabled when low. The jumper placement allows the converter to be enabled or disabled.

Under-voltage lockout can be implemented by setting the R6 and R7 resistors to transition the Enable (EN) input low as the supply voltage drops. The equation to set the values for R6 and R7 is:

$$\text{DisableVoltage} = \text{ENTHRES} \times \left(1 + \frac{R6}{R7}\right) \text{ where the ENTHRES ~ 1V.} \quad (1)$$

Resistor R7 is not populated on this EVM to reduce the quiescent supply current if this feature is not required.

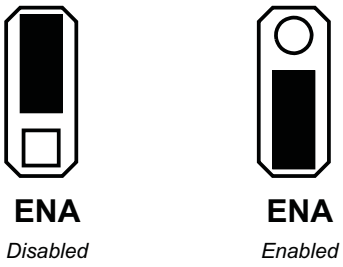


Figure 2. Enable Jumper Settings

JP3 – Slew Rate is the jumper used to set the slew rate for the switch pin. The device slew rate should be set between 15ns and 200ns. Slower slew rates can improve EMI performance, but they will increase switching losses. Jumper resistors allow the slew rate to be set to four set points. The user can set a specific slew rate by changing one of the slew rate set resistors – R8, R9 or R10. Note that the slew rate should be set to 1V/1.2ns, if the EVM is configured for a 2MHz switch in frequency.

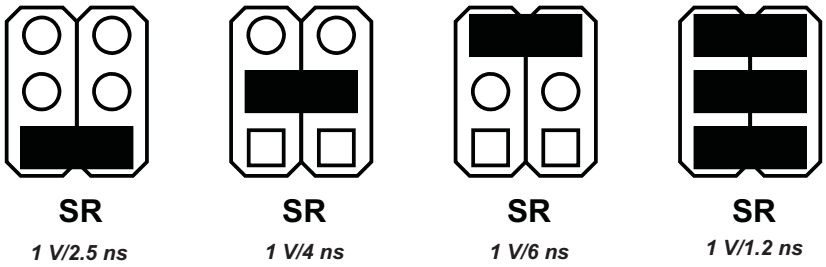


Figure 3. Slew Rate Settings

JP4 – Delay is the jumper used to set the delay time to assert the RESET pin low after the supply has exceeded the programmed Vreg_RST voltage. The delay may be programmed in the range of 2.2 ms to 200 ms. Jumper capacitors allow the reset delay to be set to four set points. The user can set a specific delay time by changing one of the delay capacitors – C13, C14 or C15.

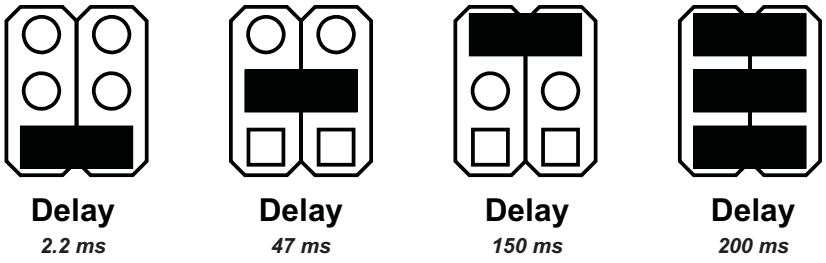


Figure 4. Reset Delay Time Settings

2.2 Setup

The input voltage range for the converter is 3.6 volts to 48 volts. A load should be applied to the Output terminal for proper operation.

2.3 Operation

For proper operation of the TPS54362, JP1, JP2, JP3 and JP4 should be properly configured. The recommended setting, using shorting blocks.

JP1 to Enabled
JP2 to Enabled
JP3 to 1V/2.5ns

JP4 to 200ms

In this configuration, the device will power up when power is applied.

JP1 LPM selects how Low Power Mode is set, Enabled or Disabled. JP2 ENA turns the device on or off. JP3 SR selects the Slew Rate for the switch pin, 1V/2.5ns, 1V/4ns, 1V/6ns or 1V/1.2ns. JP4 Delay selects the reset delay time for the device, 2.2ms, 47ms, 150ms or 200ms.

3 Board Layout

Figure 5, Figure 6 and Figure 7 show the board layout for the TPS54362EVM PWB. The EVM offers resistors, capacitors and jumpers to program the switch pin Slew Rate and regulator turn on Delay. Jumpers are also provided to Enable the device and to enable the Low Power Mode option.

The TPS54362 converter offers high efficiency, but does dissipate power. The PowerPAD™ package offers an exposed thermal pad to enhance thermal performance. This must be soldered to the copper landing on the PCB for optimal performance. The PCB provides 1 oz copper planes on the top and bottom to dissipate heat.

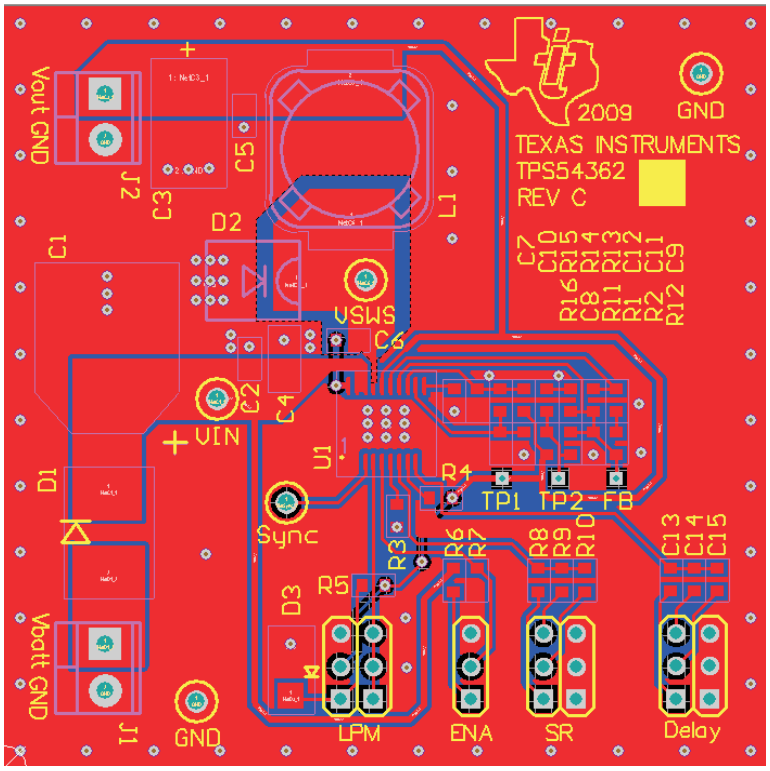


Figure 5. Top Assembly Layer

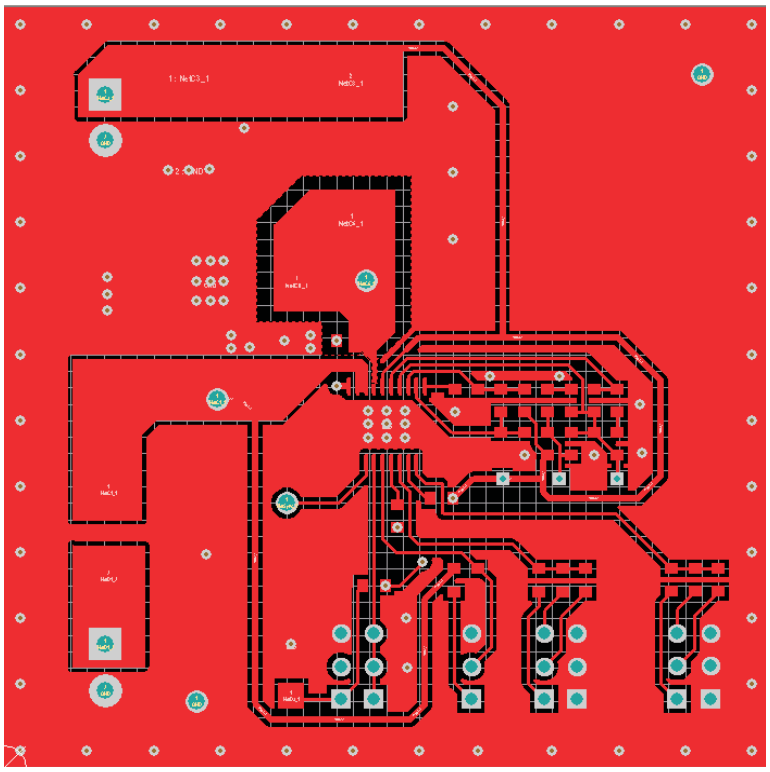


Figure 6. Top Layer Routing

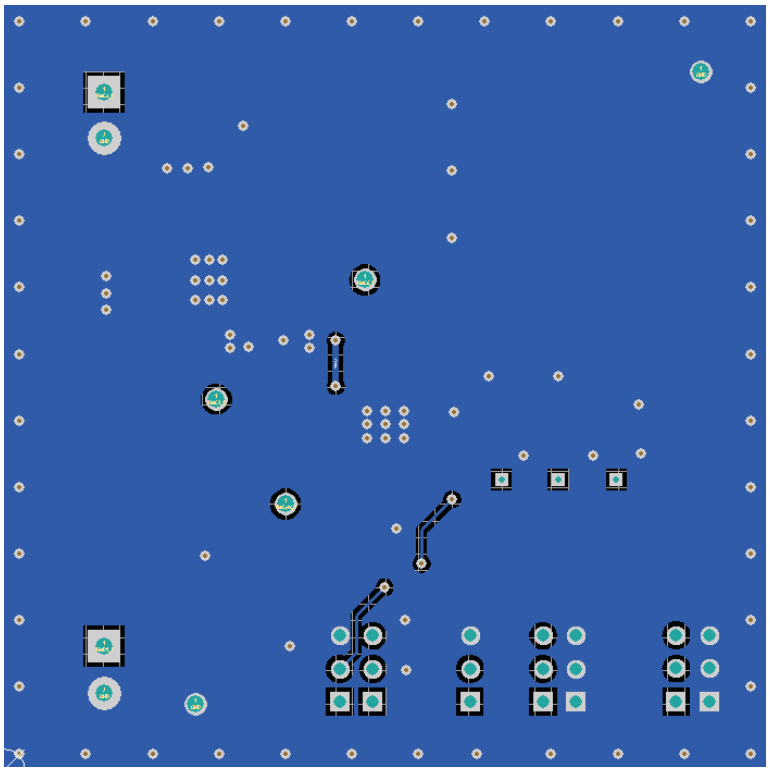


Figure 7. Bottom Layer Routing

4 Schematic and Bill of Materials

4.1 Schematic

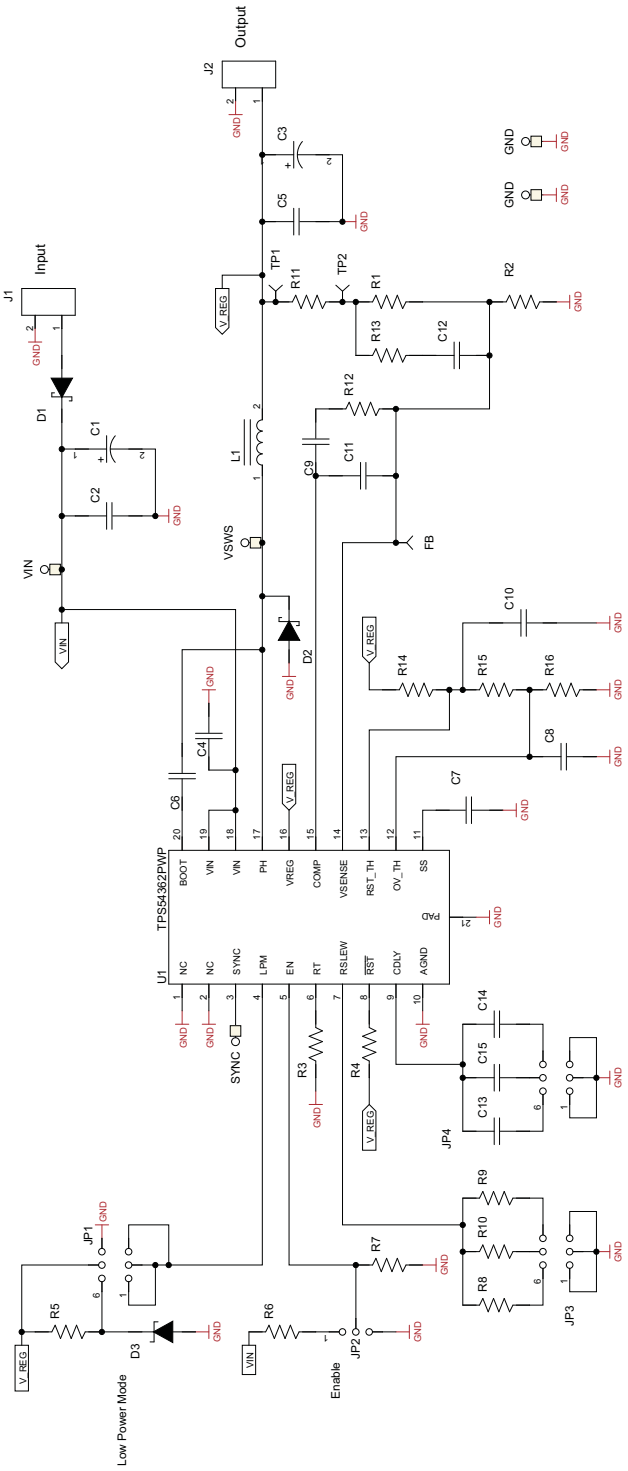


Figure 8. TPS54362EVM Schematic

4.2 Bill of Materials

Table 2. TPS54362EVM Bill of Materials for 500 kHz Configuration

Count	Ref Des	Description	Size	MFR	Part Number
1	C1	Capacitor, electrolytic, 220uF, 50V	10.3mm x 10.3mm	Panasonic	EEVFK1H221P
3	C2, C5, C6	Capacitor, ceramic, 0.1uF, 50V, 10%	0603	muRata	GCM188R71H104KA57B
1	C3	Capacitor, tantalum, 100uF, 16V, 10%	7343-31	AVX	TPSD107M016R0060
1	C4	Capacitor, ceramic, 1uF, 50V, 10%	1206	muRata	GCM31MR71H105KA55
1	C7	Capacitor, ceramic, 4.7nF, 50V, 10%	0603	muRata	GCM188R71H472KA37B
1	C8	Capacitor, ceramic, 56pF, 50V, 10%	0603	muRata	GCM188R71H563KA57B
1	C9	Capacitor, ceramic, 330pF, 50V, 10%	0603	muRata	GCM1885C1H331JA16B
2	C10, C11	Capacitor, ceramic, 22pF, 50V, 10%	0603	muRata	GCM1885C1H220JA16B
1	C12	Capacitor, ceramic, 220pF, 50V, 10%	0603	muRata	GCM1885C1H221JA16B
1	C13	Capacitor, ceramic, 2.2nF, 50V, 10%	0603	muRata	GCM1885C1H222JA16B
1	C14	Capacitor, ceramic, 150nF, 50V, 10%	0603	muRata	GCM188R71E154KA37B
1	C15	Capacitor, ceramic, 47nF, 50V, 10%	0603	muRata	GCM188R71H473KA57B
2	D1, D2	Diode, Schottky, 3A, 100V	SMC	IR	30BQ100
1	D3	Diode, Zener, 1A, 5V	SMA	Diodes	SMAZ5V1-13
2	J1, J2	Terminal block, 2-pin, 6A, 3.5mm	0.25 x 0.27	OST	ED1514
5	Sync, GND, GND, VIN, VSWS	Test point, 52-mil	0.052	Std	Std
3	Delay, LPM, SR	Header, 6-pin, 100-mil spacing, (36-pin strip)	0.100 x 3	Sullins	PEC06DAAN
1	ENA	Header, 3-pin, 100-mil spacing, (36-pin strip)	0.100 x 3	Sullins	PEC03SAAN
6	DELAY(x3), ENA, LPM, SR	Connector jumper, shorting, 100-mil spacing	0.100	Sullins	SPC02SYAN
1	L1	Inductor, SMT, 22-uH	12.3mm x 12.3mm	Coilcraft	MSS1278T-223
1	R1	Resistor, chip, 187-kΩ, 1/16W, 1%	0603	Std	Std
1	R2	Resistor, chip, 35.7-kΩ, 1/16W, 1%	0603	Std	Std
1	R3	Resistor, chip, 221-kΩ, 1/16W, 1%	0603	Std	Std
2	R4	Resistor, chip, 2-kΩ, 1/16W, 1%	0603	Std	Std
3	R5, R6, R8	Resistor, chip, 30.1-kΩ, 1/16W, 1%	0603	Std	Std
1	R7	Do not populate			
1	R9	Resistor, chip, 68.1-kΩ, 1/16W, 1%	0603	Std	Std
1	R10	Resistor, chip, 47.5-kΩ, 1/16W, 1%	0603	Std	Std
1	R11	Resistor, chip, 49.9-Ω, 1/16W, 1%	0603	Std	Std
1	R12	Resistor, chip, 274-kΩ, 1/16W, 1%	0603	Std	Std
1	R13	Resistor, chip, 2.55-kΩ, 1/16W, 1%	0603	Std	Std
1	R14	Resistor, chip, 82.5-kΩ, 1/16W, 1%	0603	Std	Std
1	R15	Resistor, chip, 2.32-kΩ, 1/16W, 1%	0603	Std	Std
1	R16	Resistor, chip, 15-kΩ, 1/16W, 1%	0603	Std	STD
1	U1	IC, TPS54362QPWPQ1		TI	TPS54362QPWPQ1
	-	PCB, 2.3-inch x 2.3-inch x 0.062		Any	TPS54362, REV C

Table 3. TPS54362EVM Bill of Materials for 2 MHz Configuration

Count	Ref Des	Description	Size	MFR	Part Number
1	C1	Capacitor, electrolytic, 220uF, 50V	10.3mm x 10.3mm	Panasonic	EEVFK1H221P
3	C2, C5, C6	Capacitor, ceramic, 0.1uF, 50V, 10%	0603	muRata	GCM188R71H104KA57B
1	C3	Capacitor, tantalum, 100uF, 16V, 10%	7343-31	AVX	TPSD107M016R0060
1	C4	Capacitor, ceramic, 1uF, 50V, 10%	1206	muRata	GCM31MR71H105KA55
1	C8	Capacitor, ceramic, 56pF, 50V, 10%	0603	muRata	GCM188R71H563KA57B
1	C7	Capacitor, ceramic, 4.7nF, 50V, 10%	0603	muRata	GCM188R71H472KA37B
1	C9	Capacitor, ceramic, 82pF, 50V, 10%	0603	muRata	GCM1885C1H820JA16B
2	C10, C11	Capacitor, ceramic, 12pF, 50V, 10%	0603	muRata	GCM1885C1H120JA16B
1	C12	Capacitor, ceramic, 120pF, 50V, 10%	0603	muRata	GCM1885C1H121JA16B
1	C13	Capacitor, ceramic, 2.2nF, 50V, 10%	0603	muRata	GCM1885C1H222JA16B
1	C14	Capacitor, ceramic, 150nF, 50V, 10%	0603	muRata	GCM188R71E154KA37B
1	C15	Capacitor, ceramic, 47nF, 50V, 10%	0603	muRata	GCM188R71H473KA57B
2	D1, D2	Diode, Schottky, 3A, 100V	SMC	IR	30BQ100
1	D3	Diode, Zener, 1A, 5V	SMA	Diodes	SMAZ5V1-13
2	J1, J2	Terminal block, 2-pin, 6A, 3.5mm	0.25 x 0.27	OST	ED1514
5	Sync, GND, GND, VIN, VSWS	Test point, 52-mil	0.052	Std	Std
3	Delay, LPM, SR	Header, 6-pin, 100-mil spacing, (36-pin strip)	0.100 x 3	Sullins	PTC36CAAN
1	ENA	Header, 3-pin, 100-mil spacing, (36-pin strip)	0.100 x 3	Sullins	PTC36CAAN
6	DELAY (x3), ENA, LPM, SR	Connector jumper, shorting, 100-mil spacing	0.100	Sullins	SPC02SYAN
1	L1	Inductor, SMT, 4.7-uH	12.3mm x 12.3mm	Coilcraft	MSS1278T-4R7
1	R1	Resistor, chip, 187-kΩ , 1/16W, 1%	0603	Std	Std
1	R2	Resistor, chip, 35.7-kΩ , 1/16W, 1%	0603	Std	Std
1	R3	Resistor, chip, 50-kΩ , 1/16W, 1%	0603	Std	Std
1	R4	Resistor, chip, 2-kΩ , 1/16W, 1%	0603	Std	Std
2	R5, R6	Resistor, chip, 30.1-kΩ , 1/16W, 1%	0603	Std	Std
1	R7	Do not populate			
1	R8	Resistor, chip, 14.7-kΩ , 1/16W, 1%	0603	Std	Std
1	R9	Resistor, chip, 68.1-kΩ , 1/16W, 1%	0603	Std	Std
1	R10	Resistor, chip, 47.5-kΩ , 1/16W, 1%	0603	Std	Std
1	R11	Resistor, chip, 49.9-Ω, 1/16W, 1%	0603	Std	Std
1	R12	Resistor, chip, 511-kΩ , 1/16W, 1%	0603	Std	Std
1	R13	Resistor, chip, 1.37-kΩ , 1/16W, 1%	0603	Std	Std
1	R14	Resistor, chip, 82.5-kΩ , 1/16W, 1%	0603	Std	Std
1	R15	Resistor, chip, 2.32-kΩ , 1/16W, 1%	0603	Std	Std
1	R16	Resistor, chip, 15-kΩ , 1/16W, 1% IC,	0603	Std	Std
1	U1	TPS54362QPWPQ1		TI	TPS54362QPWPQ1
	-	PCB, 2.3-inch x 2.3-inch x 0.062		Any	TPS54362, REV C

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